

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-45°C TO 125°C (NOTES 1)	STORAGE TEMPERATURE RANGE	-10°C TO 60°C (NOTE2)	
	VOLTAGE	150V AC	APPLICABLE CONNECTOR	DF9M(A) - 41S - 1V (32)	
	CURRENT	0.5A			
SPECIFICATIONS					
ITEM	TEST METHOD	REQUIREMENTS	QT	AT	
CONSTRUCTION					
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X	
MARKING	CONFIRMED VISUALLY.		X	X	
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE	100m A (DC OR 1000 Hz).	50mΩ MAX.	X	-	
INSULATION RESISTANCE	100V DC.	500MΩ MIN.	X	-	
VOLTAGE PROOF	250V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	-	
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION	30TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-	
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-	
SHOCK	490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-	
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -65→ 5 TO 35→125→ 5 TO 35°C TIME 30→10 TO 15→ 30→10TO15min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-	
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	-	
HEAT RESISTANCE OF SOLDERING	(1)REFLOW SOLDERING 《REFLOW AREA》 MAX250°C, 220°C FOR 60 SECONDS MAX. 《PREHEATING AREA》 150 TO 180°C 90~120 SECONDS. MAXIMUM TWICE ACTION IS ALLOWED UNDER THE SAME CONDITION. (2) MANUAL SOLDELING SOLDERING IRON TEMPERATURE 380°C SOLDERING TIME : WITHIN 3 SECONDS. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	-	
SOLDERABILITY	SOLDERING TEMPARATURE:245±5°C DURATION OF IMMERSION : SOLDERING FOR 3±0.5 SECONDS	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMersed.	X	-	
REMARKS					
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT.					
NOTE2:STORAGEIS DEFINED AS LONG-TERM STORAGE OF UNUSED PRODUCTS.					
APPLY OPERATION TEMPERATURE RANGE TO PRODUCTS MOUNTED ON PCB WITHOUT POWER SUPPLY.					
UNLESS OTHERWISE SPECIFIED , REFER TO JIS C 5402 .					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△					
			APPROVED	KH. IKEDA	08.02.26
			CHECKED	TS. MIYAZAKI	08.02.26
			DESIGNED	AR. TAKAHASHI	08.02.26
			DRAWN	AK. AOYAGI	08.02.25
Note	QT:Qualification Test AT:Assurance Test X:Applicable Test		DRAWING NO.	ELC4-160518-01	
	SPECIFICATION SHEET		PART NO.	DF9M-41P-1V (32)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL540-0229-1-32	△ 1/1